# PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Masakazu OKAI	07/06/2010
Kenji TAMAI	07/06/2010
Toru UENO	07/06/2010

### **RECEIVING PARTY DATA**

Name:	Hitachi High-Technologies Corporation	
Street Address:	24-14, Nishishinbashi 1-chome, Minato-ku,	
City:	Tokyo	
State/Country:	JAPAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12846323

#### **CORRESPONDENCE DATA**

Fax Number: (703)312-6666

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703-312-6600

Email: svannarath@antonelli.com

Correspondent Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP Address Line 1: 1300 NORTH SEVENTEENTH STREET

Address Line 2: SUITE 1800

Address Line 4: ARLINGTON, VIRGINIA 22209-3873

ATTORNEY DOCKET NUMBER: 500.50964X00

NAME OF SUBMITTER: Melvin Kraus

Total Attachments: 1

source=50964X00ASN#page1.tif

OP \$40.00 1284

PATENT REEL: 024761 FRAME: 0671

# **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

VACUUM PROCESSING APPARATUS AND VACUUM PROCESSING METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside signatures:

RECORDED: 07/29/2010

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	Masahagu Chai	7/6/2010
2)	Masakazu OKAI  Masakazu OKAI  Kenji Tamai  Kenji TAMAI  Toru Meno	7/6/2010
3)	Toru Meno Toru UENO	7/6/2010
4)		
5)		
6)		
7)		
8)		
9)		<u> </u>
10)		

PATENT REEL: 024761 FRAME: 0672